

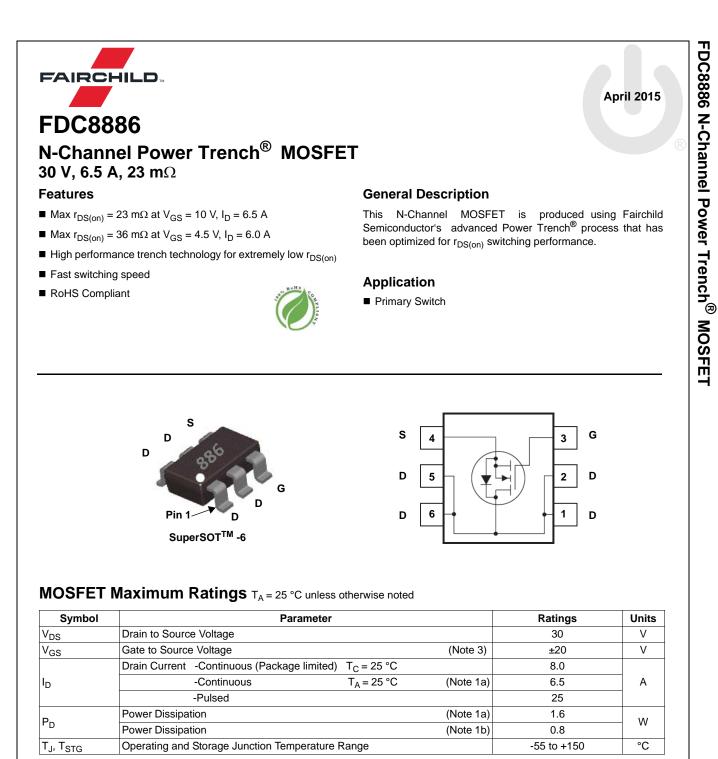
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## **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case	30	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 78	C/W

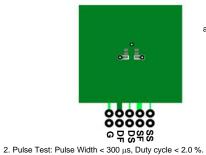
## **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.886	FDC8886	SSOT-6	7 "	8 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	acteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	30			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		18		mV/°C	
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA	
On Chara	acteristics	· · · · · ·					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	1.2	1.9	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6.5 A		19	23	mΩ	
		$V_{GS} = 4.5 \text{ V}, I_D = 6.0 \text{ A}$		30	36		
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6.5 A, T <sub>J</sub> = 125 °C		25	30		
<b>9</b> FS	Forward Transconductance	$V_{DD} = 5 \text{ V}, I_D = 6.5 \text{ A}$		24		S	
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		348 135 16	465 180 25	pF pF pF	
R <sub>q</sub>	Gate Resistance			1.2	20	Ω	
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time	-		5	10	ns	
t <sub>r</sub>	Rise Time	$V_{DD} = 15 \text{ V}, \text{ I}_{D} = 6.5 \text{ A},$		1	10	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		11	19	ns	
t <sub>f</sub>	Fall Time			1	10 7.4	ns	
-1	Tatal Cata Channe			5.3	7.4	nC	
	Total Gate Charge	$V_{GS} = 0 \text{ V to } 10 \text{ V}$		0 E	2 5		
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 15 \text{ V}$		2.5	3.5	nC	
Q <sub>g(TOT)</sub> Q <sub>gs</sub>	Total Gate Charge Total Gate Charge			1.0	3.5	nC	
Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total Gate ChargeTotal Gate ChargeGate to Drain "Miller" Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 15 \text{ V}$		-	3.5	-	
Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-So	Total Gate Charge         Total Gate Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics	$V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V}$ $I_D = 6.5 \text{ A}$		1.0 0.8		nC nC	
Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total Gate Charge         Total Gate Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics         Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 15 \text{ V}$		1.0 0.8 0.86	1.2	nC	
Q <sub>g(TOT)</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-So	Total Gate Charge         Total Gate Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics	$V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V}$ $I_D = 6.5 \text{ A}$		1.0 0.8		nC nC	

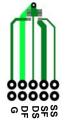
Q<sub>rr</sub> NOTES:

 $R_{0,C}$  is guaranteed by design while  $R_{0CA}$  is determined by the user's board design.



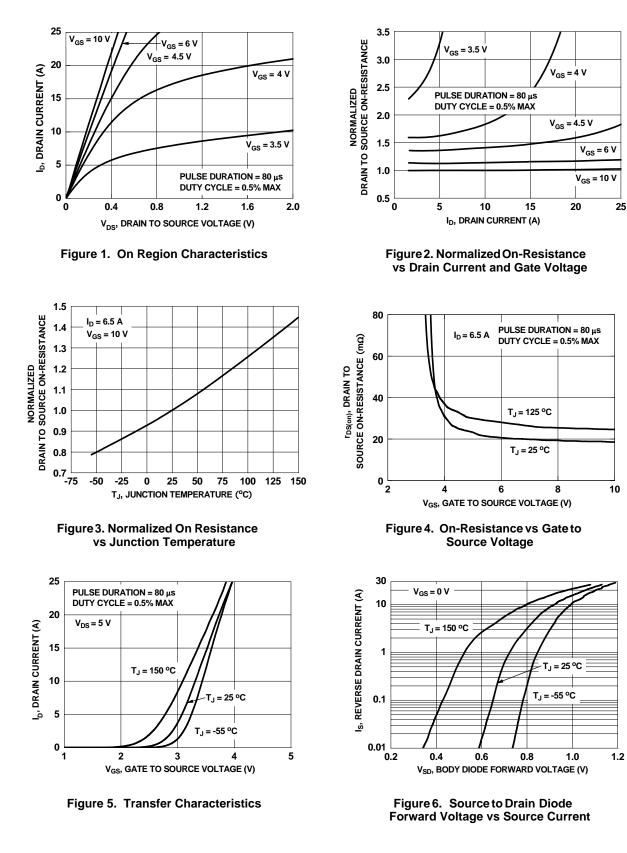
a. 78 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

3. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.



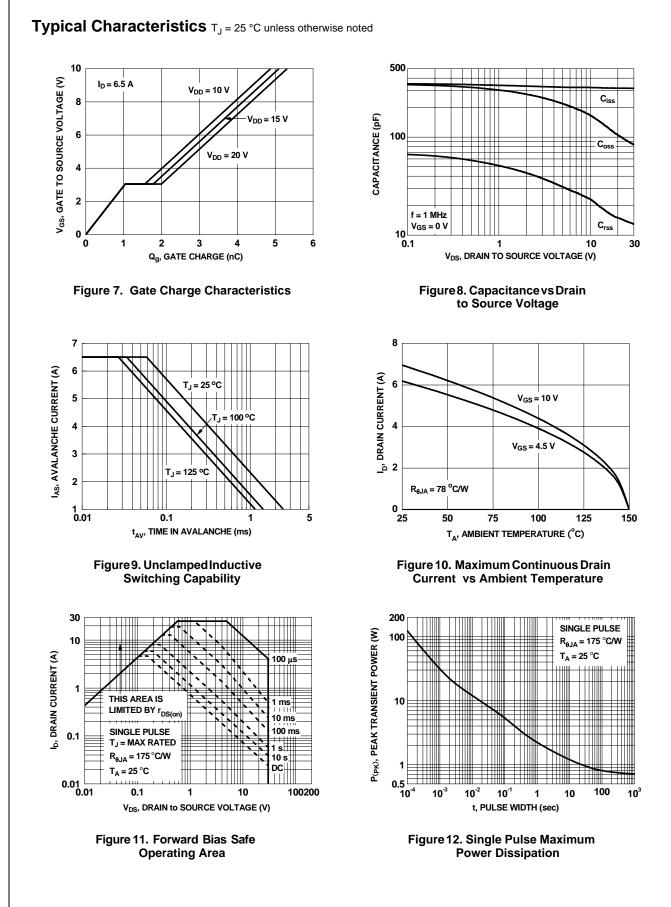
b.175 °C/W when mounted on a minimum pad of 2 oz copper

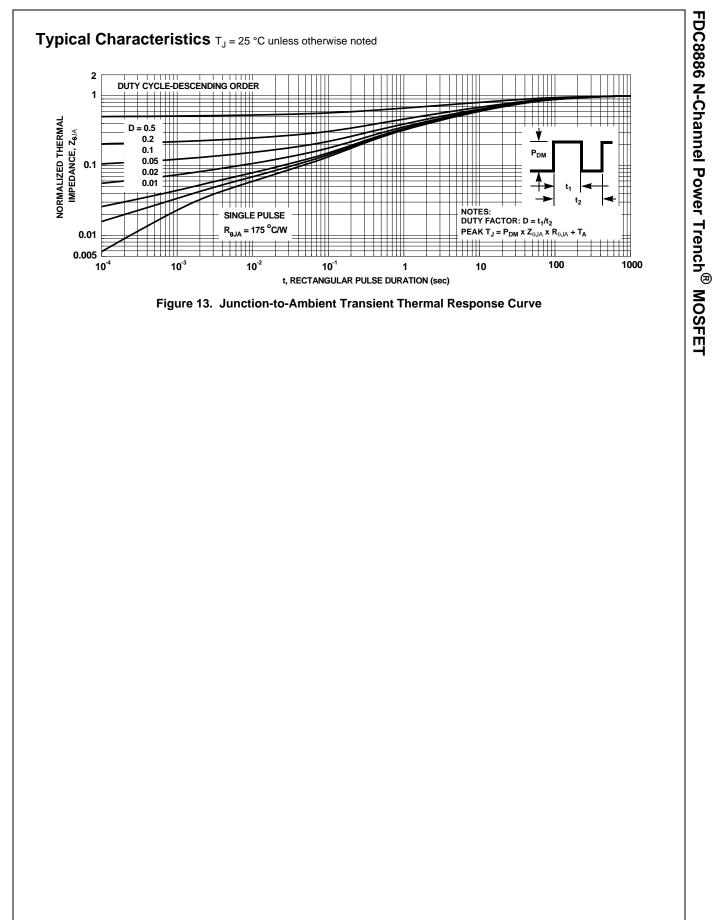
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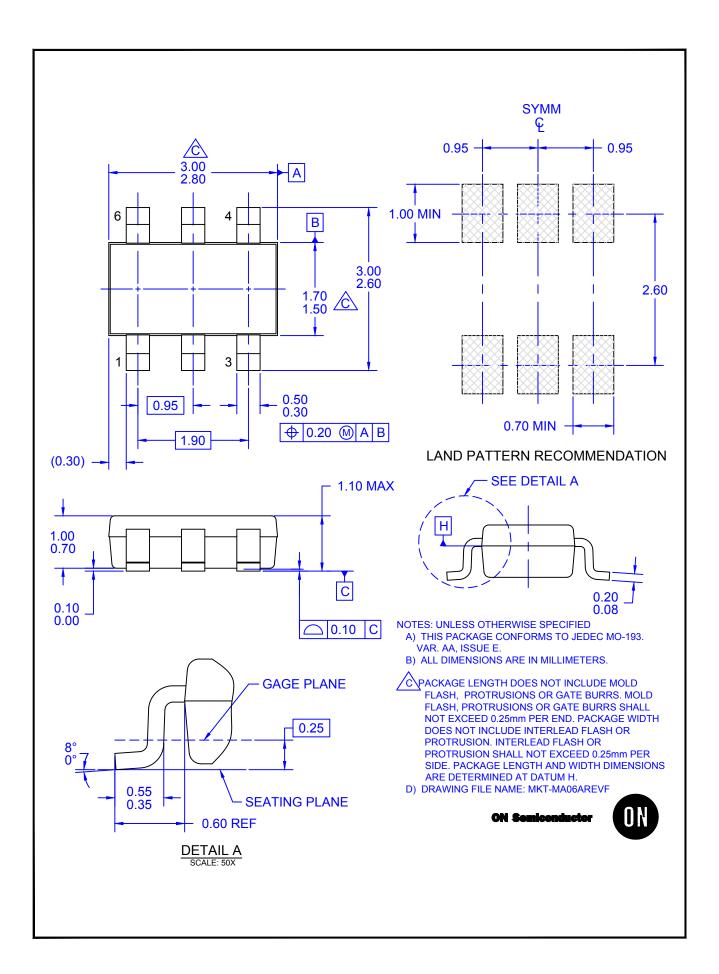


# Typical Characteristics T<sub>J</sub> = 25 °C unless otherwise noted









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